MBR115P MBR120P MBR130P MBR140P See Page 3-47



MBR320M MBR330M MBR340M

SCHOTTKY BARRIER RECTIFIERS

3 AMPERE 20, 30, 40 VOLTS

HOT CARRIER POWER RECTIFIERS

. . . employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State of the art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low v_F
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- High Surge Capacity

MAXIMUM RATINGS

| Rating | Symbol | MBR320M | MBR330M | MBR340M | Unit |
|---|--|-------------------------|---------|---------|-------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 20 | 30 | 40 | Volts |
| Non-Repetitive Peak Reverse Voltage | V _{RSM} | 24 | 36 | 48 | Volts |
| Average Rectified Forward Current VR(equiv) $\leq 0.2 \text{VR} (\text{de})$, $T_{\text{C}} = 65^{\circ}\text{C}$ VR(equiv) $\leq 0.2 \text{VR} (\text{de})$, $T_{\text{L}} = 90^{\circ}\text{C}$ ($R_{\theta} \text{JA} = 25^{\circ}\text{C/W}$, P.C. Board Mounting, See Note 3) | ю | 15 3.0 | | | Amp |
| Ambient Temperature Rated V_R (dc), $P_F(AV) = 0$ $R_{\theta JA} = 25^{\circ}C/W$ | ТА | 65 | 60 | 55 | °C |
| Non-Repetitive Peak Surge Current (surge applied at rated load condi- tions, halfwave, single phase 60 Hz) | ^I FSM | ── 500 (for 1 cycle) ── | | | Amp |
| Operating and Storage Junction Temperature Range (Reverse Voltage applied) | T _J ,T _{stg} | -65 to +125 | | | °C |
| Peak Operating Junction Temperature (Forward Current Applied) | T _{J(pk)} | - | — 150 — | | °C |

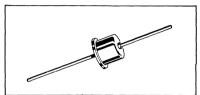
THERMAL CHARACTERISTICS

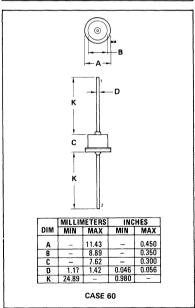
| Characteristic | Symbol | Max | Unit |
|--------------------------------------|---------------|-----|------|
| Thermal Resistance, Junction to Case | $R_{	heta}JC$ | 3.0 | °C/W |

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|--------|-----|-----|-------|-------|
| Maximum Instantaneous Forward Voltage (1) | ٧F | | | | Volts |
| (i _F = 5.0 Amp) | 1 | - | - | 0.450 | 1 |
| Maximum Instantaneous Reverse Current @ rated dc Voltage (1) | iR | | | | mA |
| T _C = 25°C | | - | - | 10 | 1 |
| T _C = 25 ^o C T _C = 100 ^o C | I | _ | _ | 75 | |

(1) Pulse Test: Pulse Width = 300 µs, Duty Cycle = 2.0%.





MECHANICAL CHARACTERISTICS

CASE: Welded, hermetically sealed construction.

FINISH: All external surfaces corrosion-resistant

and the terminal leads are readily solderable.

POLARITY: Cathode to case.

MOUNTING POSITIONS: Any

MBR320M, MBR330M, MBR340M

NOTE 1: DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.1 V_{RWM}. Proper derating may be accomplished by use of equation (1):

 $T_{A(max)} = T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)}$ (1)

TA(max) = Maximum allowable ambient temperature

T_{J(max)} = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest).

PF(AV) = Average forward power dissipation

PR(AV) = Average reverse power dissipation

 $R_{\theta JA}$ = Junction-to-ambient thermal resistance

Figures 1, 2 and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_{R} = T_{J(max)} - R_{\theta JA} P_{R(AV)}$$
 (2)

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_{R} - R_{\theta JA} P_{F(AV)}$$
(3)

Inspection of equations (2) and (3) reveals that T_R is the ambient temperature at which thermal runaway occurs or where T_J = 125°C,

when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2 and 3 as a difference in the rate of change of the slope in the vicinity of 115°C. The data of Figures 1, 2 and 3 is based upon dc conditions. For use in common rectifier circuits, Table I indicates suggested factors for an equivalent dc voltage to use for conservative design; i.e.:

 $V_{R(equiv)} = V_{IN(PK)} \times F$ (4)

The Factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

Example: Find $T_{\dot{A}(max)}$ for MBR340M operated in a 12-Volt dc supply using a bridge circuit with capacitive filter such that $1_{DC}=10.4$ (IF(AV) = 5.0, I(PK)/I(AV) = 10, Input Voltage = 10.0 V(rms), $R_{\dot{\theta}JA}=10^{0}$ C/W.

Step 1: Find $V_{R(equiv)}$. Read F = 0.65 from Table I \therefore $V_{R(equiv)}$ = (1.41)(10)(0.65) = 9.2 V

Find T_R from Figure 3. Read T_R = 117°C @ V_R =

9.2 V & $R_{\theta JA} = 10^{O}$ C/W. Step 3: Find $P_{E(AV)}$ from Figure 4. Read $P_{E(AV)} = 6.3$ W

@ I(PK) = 10 & IF(AV) = 5 A

Step 4: Find $T_{A(max)}$ from equation (3). $T_{A(max)} = 117-(10)$ (6.3) = 54°C.

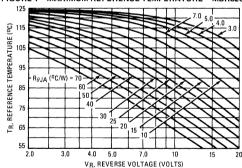
TABLE I - VALUES FOR FACTOR F

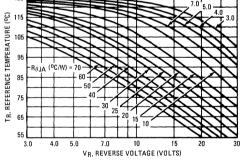
| Circuit | Half | Half Wave | | Full Wave, Bridge | | Wave, apped (1), (2) |
|-------------|-----------|----------------|-----------|-------------------|-----------|-------------------------|
| Load | Resistive | Capacitive (1) | Resistive | Capacitive | Resistive | Capacitive |
| Sine Wave | 0.5 | 1.3 | 0.5 | 0.65 | 1.0 | 1.3 |
| Square Wave | 0.75 | 1.5 | 0.75 | 0.75 | 1.5 | 1.5 |

(1) Note that VR(PK)≈2 Vin(PK)

(2)Use line to center tap voltage for V_{in} .

FIGURE 1 – MAXIMUM REFERENCE TEMPERATURE – MBR320M FIGURE 2 – MAXIMUM REFERENCE TEMPERATURE – MBR330M







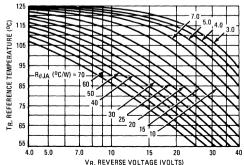
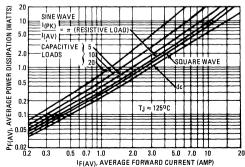
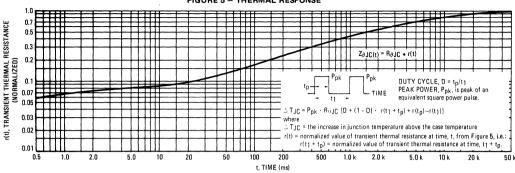


FIGURE 4 - FORWARD POWER DISSIPATION

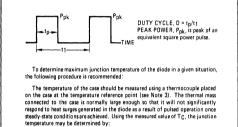


THERMAL CHARACTERISTICS

FIGURE 5 - THERMAL RESPONSE



NOTE 2 - FINDING JUNCTION TEMPERATURE



TJ = TC + - TJC

where A TJC is the increase in junction temperature above the case temperature. It may be determined by:

 $\triangle \mathsf{TJC} = \mathsf{Ppk} \cdot \mathsf{R}_{\theta} \mathsf{JC} \left[\mathsf{D} + (\mathsf{1} - \mathsf{D}) \cdot \mathsf{r}(\mathsf{t}_1 + \mathsf{t}_p) + \mathsf{r}(\mathsf{t}_p) - \mathsf{r}(\mathsf{t}_1) \right]$

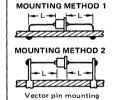
r(t) = normalized value of transient thermal resistance at time, t, from Figure $r(t_1 + t_p) = normalized$ value of transient thermal resistance at time $t_1 + t_p$.

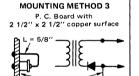
NOTE 3 - MOUNTING DATA

Data shown for thermal resistance junction-to-ambient (RAJA) for the mountings shown is to be used as typical guideline values for preliminary engineering.

TYPICAL VALUES FOR ROLA IN STILL AIR

| | LEAD LENG | | |
|--------------------|-----------|----|-----------------|
| MOUNTING METHOD | 1/4 | 1 | $R_{\theta JA}$ |
| 1 | 55 | 60 | OC/W |
| 2 | 65 | 70 | °C/W |
| 3 | 25 | | oC/W |

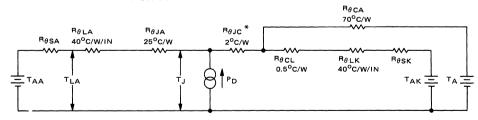




Board Ground

Plane

FIGURE 6 - APPROXIMATE THERMAL CIRCUIT MODEL



Use of the above model permits calculation of average junction temperature for any mounting situation. Lowest values of thermal resistance will occur when the cathode lead is brought as close as possible to a heat dissipator; as heat conduction through the anode lead is small. Terms in the model are defined as follows:

*Case temperature reference is at cathode end.

TEMPERATURES

TA = Ambient

TAA = Anode Heat Sink Ambient TAK = Cathode Heat Sink Ambient

T_{LA} = Anode Lead

T_{LK} = Cathode Lead T_J = Junction

THERMAL RESISTANCES

 $R_{\theta CA}$ = Case to Ambient

 $R_{\theta SA}$ = Anode Lead Heat Sink to Ambient

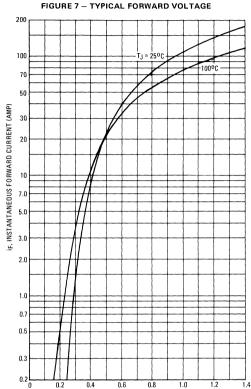
Resk = Cathode Lead Heat Sink to Ambient

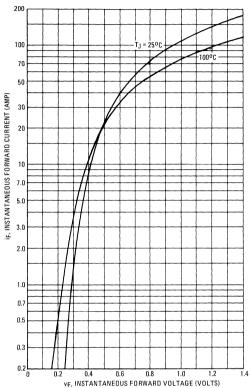
Rθ LA = Anode Lead Rθ LK = Cathode Lead

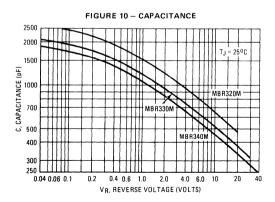
RecL = Case to Cathode Lead

 $R_{\theta JC}$ = Junction to Case

R_{θJA} = Junction to Anode Lead (S bend)









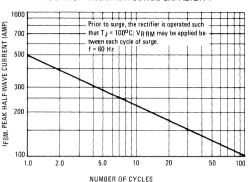
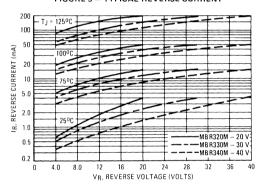


FIGURE 9 - TYPICAL REVERSE CURRENT



NOTE 4 - HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10).

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.